

Global Chip Encapsulation Material Competitive Landscape Professional Research Report 2025

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Abstracts

Market Overview

According to DIResearch's in-depth investigation and research, the global Chip Encapsulation Material market size will reach 29,964 Million USD in 2025 and is projected to reach 42,416 Million USD by 2032, with a CAGR of 5.09% (2025-2032). Notably, the China Chip Encapsulation Material market has changed rapidly in the past few years. By 2025, China's market size is expected to be Million USD, representing approximately % of the global market share.

Research Summary

Chip encapsulation material, also known as encapsulant or molding compound, is a protective material used to cover and seal semiconductor chips or integrated circuits (ICs). The main purpose of chip encapsulation is to shield the delicate circuitry inside the chip from environmental factors such as moisture, dust, and mechanical stress, ensuring the chip's reliability and longevity. The encapsulation material is applied in liquid or paste form, and it undergoes a curing process to solidify and form a protective coating around the chip. This coating not only provides physical protection but also improves the chip's thermal performance by dissipating heat generated during operation. Chip encapsulation materials come in various formulations, including epoxy, silicone, and resin-based compounds, each offering different properties such as flexibility, adhesion, and resistance to high temperatures. The choice of chip encapsulation material is critical in semiconductor manufacturing to ensure the chip's performance, reliability, and overall quality for its intended applications in electronic devices and systems.

The major global suppliers of Chip Encapsulation Material include Shennan Circuit Company Limited, Xingsen Technology, Kangqiang Electronics, Kyocera, Mitsui High-tec, Chang Wah Technology, Panasonic, Henkel, Sumitomo Bakelite, Heraeus, Tanaka, etc. The global players competition landscape in this report is divided into three tiers. The first tier comprises global leading enterprises that command a substantial market share, hold a dominant industry position, possess strong competitiveness and influence, and generate significant revenue. The second tier includes companies with a notable market presence and reputation; these firms actively follow industry leaders in product, service, or technological innovation and maintain a moderate revenue scale. The third tier consists of smaller companies with limited market share and lower brand recognition, primarily focused on local markets and generating comparatively lower revenue.

This report studies the market size, price trends and future development prospects of Chip Encapsulation Material. Focus on analysing the market share, product portfolio, prices, sales, revenue and gross profit margin of global major suppliers, as well as the market status and trends of different product types and applications in the global Chip Encapsulation Material market. The report data covers historical data from 2020 to 2024, based year in 2025 and forecast data from 2026 to 2032.

The regions and countries in the report include North America, Europe, China, APAC (excl. China), Latin America and Middle East and Africa, covering the Chip Encapsulation Material market conditions and future development trends of key regions and countries, combined with industry-related policies and the latest technological developments, analyze the development characteristics of Chip Encapsulation Material industries in various regions and countries, help companies understand the development characteristics of each region, help companies formulate business strategies, and achieve the ultimate goal of the company's global development strategy.

The data sources of this report mainly include the National Bureau of Statistics, customs databases, industry associations, corporate financial reports, third-party databases, etc. Among them, macroeconomic data mainly comes from the National Bureau of Statistics, International Economic Research Organization; industry statistical data mainly come from industry associations; company data mainly comes from interviews, public information collection, third-party reliable databases, and price data mainly comes from various markets monitoring database.

Global Key Suppliers of Chip Encapsulation Material Include:

Shennan Circuit Company Limited

Xingsen Technology

Kangqiang Electronics

Kyocera

Mitsui High-tec

Chang Wah Technology

Panasonic

Henkel

Sumitomo Bakelite

Heraeus

Tanaka

Chip Encapsulation Material Product Segment Include:

Substrates

Lead Frame

Bonding Wires

Encapsulating Resin

Others

Chip Encapsulation Material Product Application Include:

Consumer Electronics

Automotive Electronics

IT and Communication Industry

Others

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